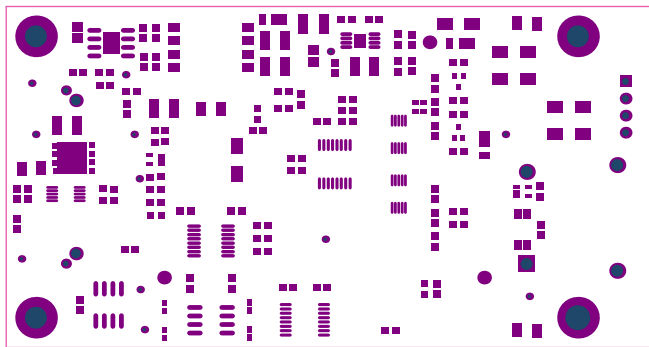
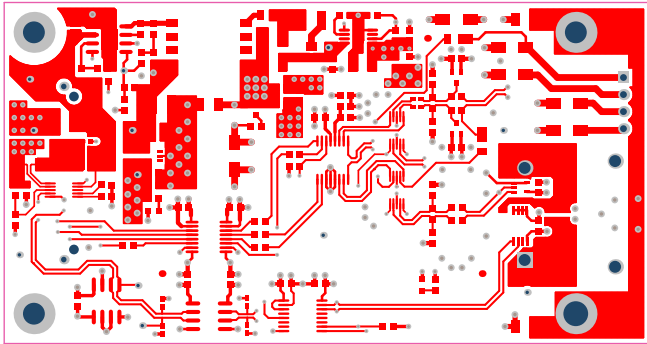


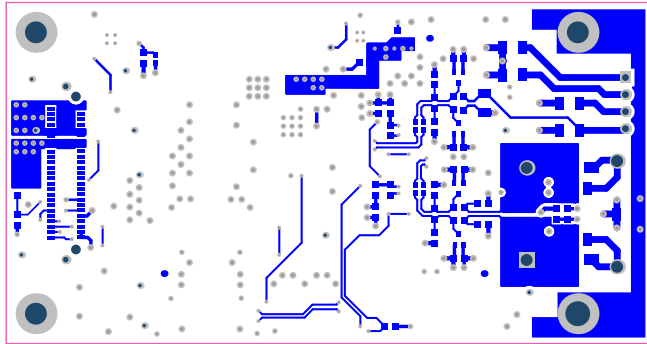
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00018	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME =Top Overlay	GENERATED: 3/26/2014 7:47:03 PM	TEXAS INSTRUMENTS	



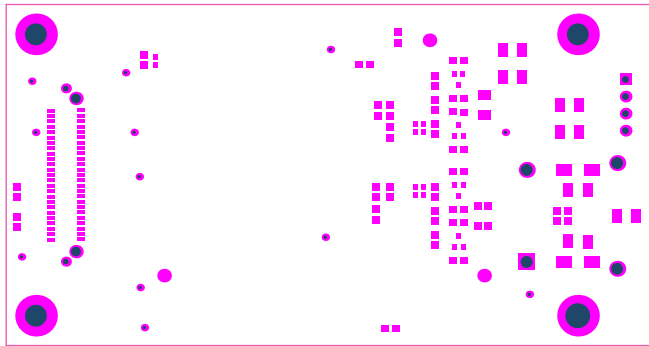
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00018	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME =Top Solder Mask	GENERATED: 3/26/2014 7:47:03 PM	TEXAS INSTRUMENTS	



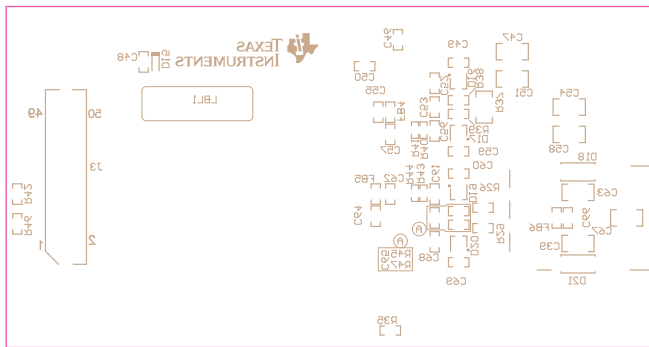
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00018	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME =Top Layer	GENERATED: 3/26/2014 7:47:04 PM	TEXAS INSTRUMENTS	



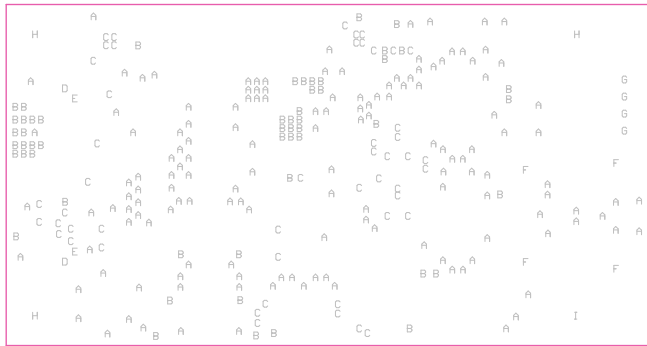
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00018	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME =Bottom Layer	GENERATED: 3/26/2014 7:47:05 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00018	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME =Bottom Solder Mask	GENERATED: 3/26/2014 7:47:06 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00018	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME =Bottom Overlay	GENERATED: 3/26/2014 7:47:06 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
C	49	12mil (0.305mm)	PTH	Round
B	54	16mil (0.406mm)	PTH	Round
A	148	20mil (0.508mm)	PTH	Round
D	2	33mil (0.838mm)	PTH	Round
G	4	40mil (1.016mm)	PTH	Round
E	2	57.087mil (1.45mm)	NPTH	Round
F	4	70mil (1.778mm)	PTH	Round
H	3	127.953mil (3.25mm)	PTH	Round
I	1	145.669mil (3.7mm)	PTH	Round
	267	Total		

Drill Table

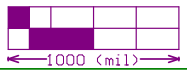
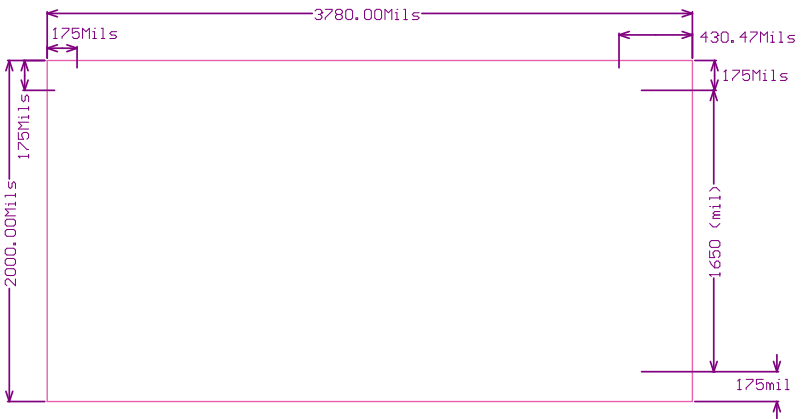
FOR 12MIL DRILL +0/-12MIL TOLERANCE

FOR 16MIL DRILL +0/-16MIL TOLERANCE

FOR PTH: +/-3MIL TOLERANCE

FOR NPTH DRILL +/-2MIL TOLERANCE

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00018	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME =Drill Drawing	GENERATED: 3/26/2014 7:47:07 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00018	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME =Board Dimensions	GENERATED: 3/26/2014 7:47:08 PM	TEXAS INSTRUMENTS	

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